

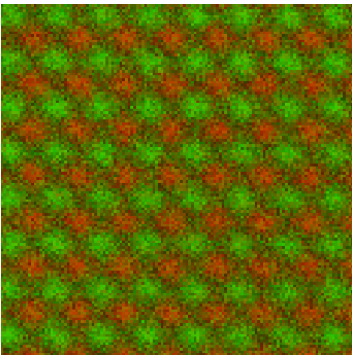
Atomic-resolution X-ray microanalysis: Efficient X-ray collection and data analysis

Paul G. Kotula

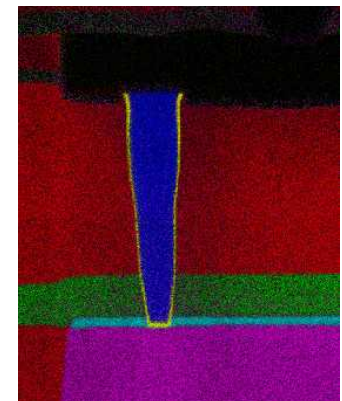
Sandia National Laboratories, Albuquerque, NM, USA

H.S. von Harrach and D. Klenov

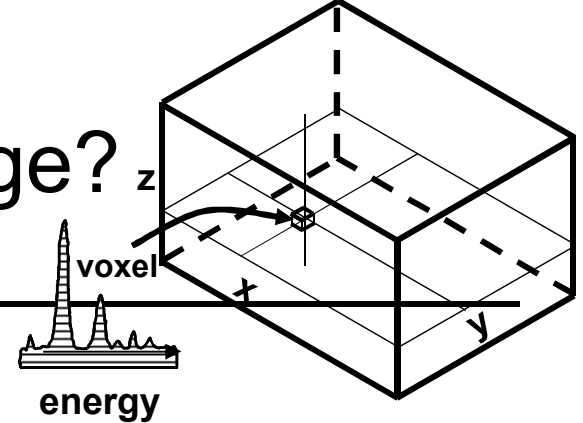
FEI Company, Eindhoven, The Netherlands



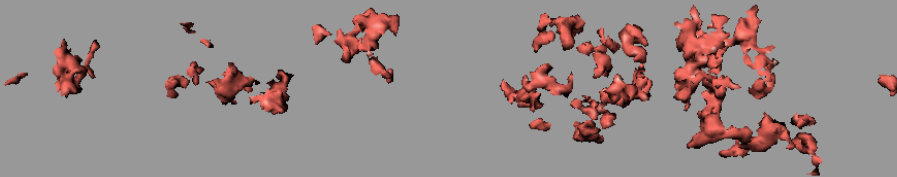
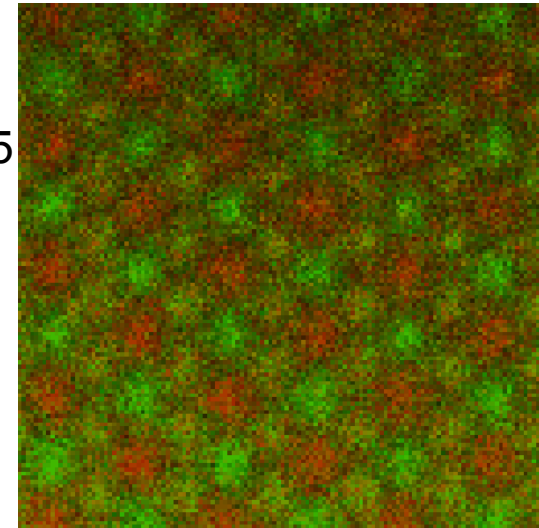
- Spectral imaging
- Multivariate statistical analysis
- Atomic-resolution x-ray microanalysis
 - Brighter sources
 - Probe correction
 - Efficient x-ray detectors
- Future applications



What is a spectral image?

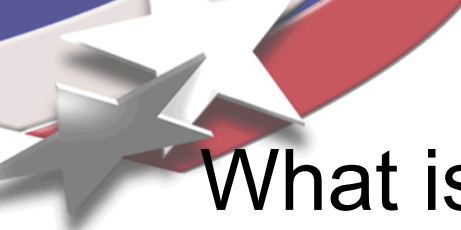


- A series of complete spectra resolved in 2- or higher dimensions
 - Conventional spectral images-2D*
 - Demonstrated in 1979 and first product by PGT in 1995
 - Tomographic spectral images-3D**
 - Direct-FIB**, Metallography
 - Computed-Tilt series of spectral images
 - Confocal
 - Resolved in other dimensions
 - Time, process condition, projection, etc.
- As far as MSA is concerned these can all be treated the same



*e.g., P.G. Kotula et al. *Microsc. Microanal.* 9 (2003) 1-17.

**e.g., P.G. Kotula et al. *Microsc. Microanal.* 12 (2006) 36-48.



What is Multivariate Statistical Analysis?

- MSA comprises many techniques for factoring spectral image data into other hopefully more useful forms
- Makes use of high-degree of redundancy in data
 - Many observations of similar, noisy spectral or image features, tens of thousands to billions
 - Noisy data can be used to advantage
 - Large number of spectral channels, 50-100000+
- Typically used to reduce dimensionality of the data and filter noise of known structure
- A 128x128 pixel by 1024 channel data set has 1024 dimensions or variables, which can be transformed so as to represent chemical information...MSA helps find the correlations
- Results should be fast and readily interpretable
 - Seconds for small data sets to at most tens of minutes for the largest data sets.



What are the basic steps of MSA?

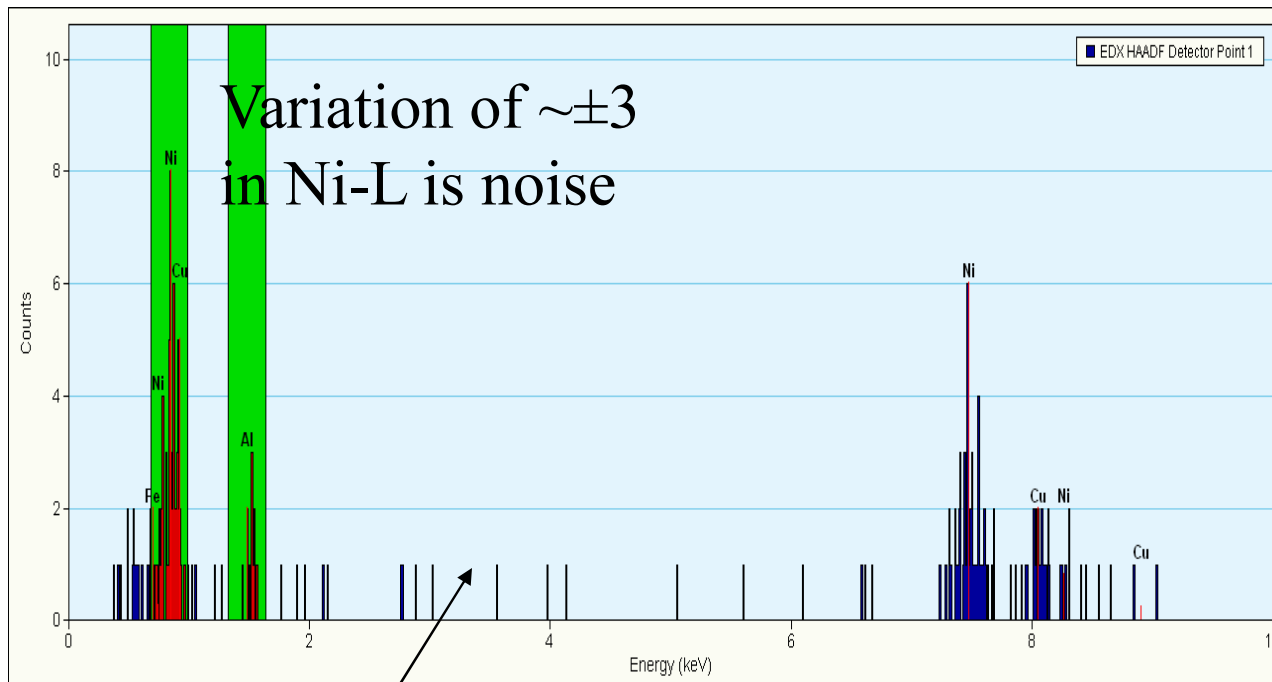
-
- Keenan, M.R., *Multivariate analysis of spectral images composed of count data*, in *Techniques and applications of hyperspectral image analysis*, H. Grahn and P. Geladi, Editors. 2007, John Wiley & Sons: Chinchester.
 - Scale data for non-uniform noise*
 - Assumption here-we know the noise structure in these counting experiments
 - Down-weights large variations in intense spectral or image features which are due to noise
 - Rank 1 approximation to the noise
 - In the image domain divide by the square-root of the mean image
 - In the spectral domain divide by the square-root of the mean spectrum
 - Essentially the same answer as maximum likelihood methods with but far less computational complexity**
 - Factor analysis
 - Inverse noise scaling

*M.R. Keenan and P.G. Kotula, *Surf. Int. Anal.* **36** (2004) 203-212

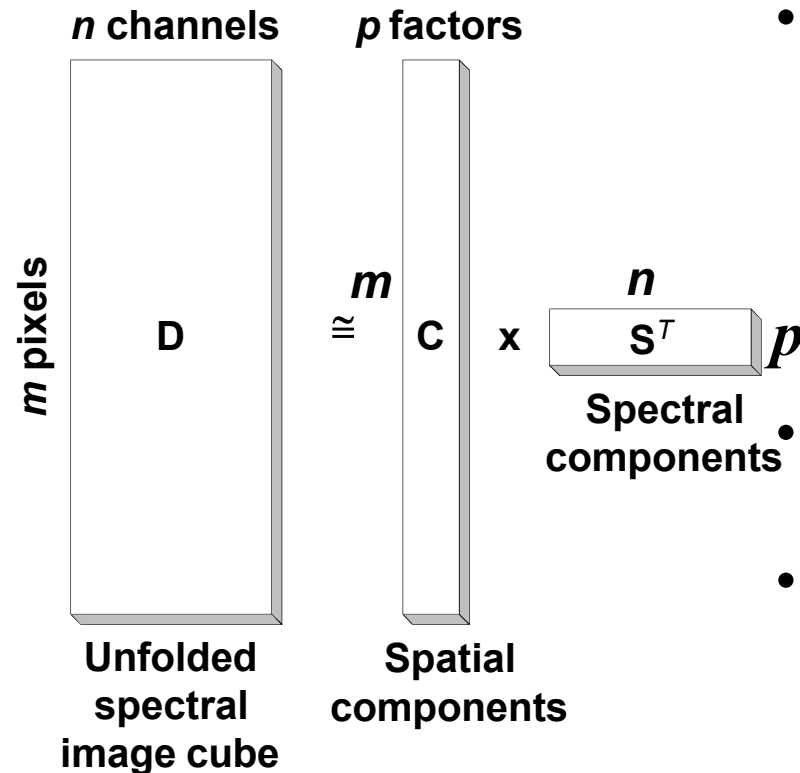
M.R. Keenan, *J. Vac. Sci. Tech. A* **23 [4] (2005) 746-750

Normalizing for noise

Typical x-ray spectrum from STEM-EDS



We have several options in our multivariate “Toolbox”



Analysis goal: Obtain an easily interpretable representation of the data

- Principal Component Analysis (PCA)
 - Factors are orthogonal
 - Factors serially maximize variance
 - Provides best LS fit to data
 - Non-physical constraints
 - Factors are abstract
- PCA + factor rotation (Varimax)*
 - Rotate factors to “simple structure”
- MCR-ALS**
 - A refinement of Rotated PCA
 - Non-negativity of C and/or S
 - Equality, closure and others
 - Constraints may not be effective
 - Bias due to error in variables

*M.R. Keenan, *Surf. Int. Anal.* **41** (2009) 79-87.

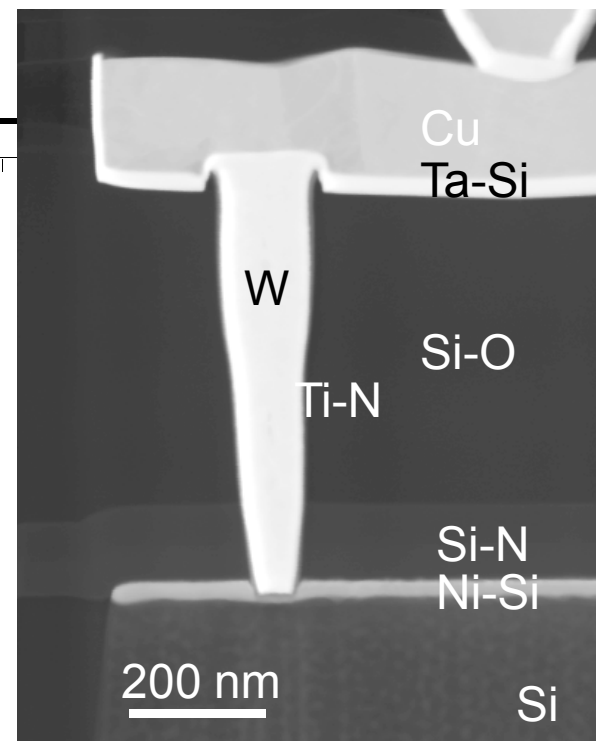
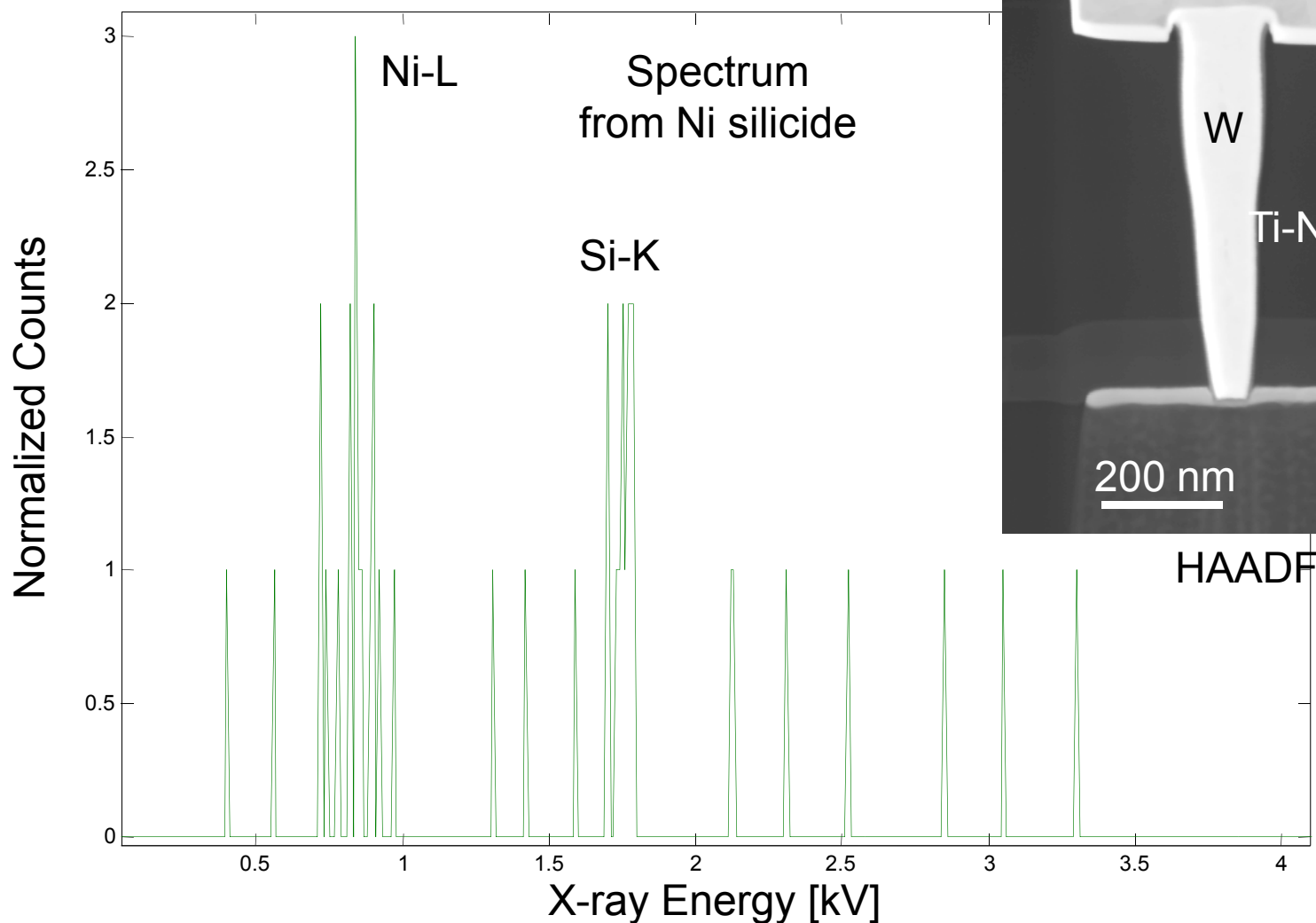
P.G. Kotula, et al. *Microsc. Microanal.* **9 (2003) 1-17.



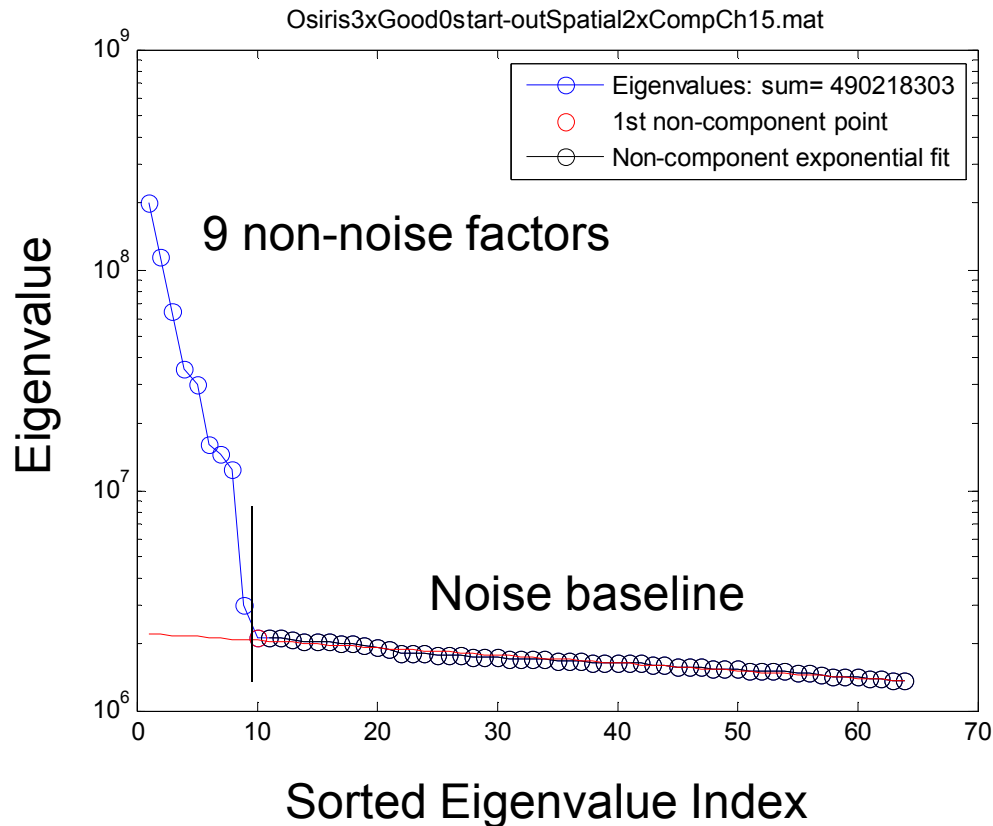
Spectral- vs. Spatial-Domain Simplicity: Analysis of CMOS

- Planarized CMOS *in-situ* lift out specimen on a Mo grid
- FEI Tecnai Osiris, 200kV FEG with SuperX (0.9sr)
- 400 x 500 pixels by 4096+channels, 2nm/pixel
- >99% sparse (~811M elements = 0, ~7.7M elements >0)
 - But it's important to note the non-zeros are for the most part randomly distributed
- Data acquisition 249 seconds @ 1.5nA or 1.245msec/pixel
- ~10.6 M total counts
 - 43 kcps summed or 11 kcounts/second/spectrometer
 - Average of 53 counts per spectrum
- Data analysis took 144 seconds on a decent lab workstation (XP-x64)

Raw spectrum from the CMOS spectral image



Eigenanalysis of the CMOS SI data



Clearly 9 factors automatically resolved above the noise



Spatial Domain Simplicity*

Often the phase viewpoint

- **$D = CS^T$ (Goal: Factor raw data into C and S...linear model)**
 - D is an m -pixel \times n -channel raw spectral-data matrix
 - S is an $n \times p$ matrix containing the p pure-component spectra shapes
 - C is an $m \times p$ matrix containing their spatial distributions/abundances
- Data is scaled to account for non-uniform (Poisson) noise**
- Number of factors to retain is chosen (Eigenanalysis)
- PCA is performed on the scaled data such the **spectral** components are orthogonal and the **spatial** components are orthonormal
- Rotate the orthonormal **spatial** components to maximize their mutual simplicity with the VARIMAX procedure
- Apply the inverse rotation to the **spectral** components which relaxes orthogonally in this domain
- Optionally: Impose non-negativity (e.g., via MCR, CLS, etc.)***
- Inversely scale the components for Poisson noise

*M.R. Keenan, *Surf. Int. Anal.* **41** (2009) 79-87.

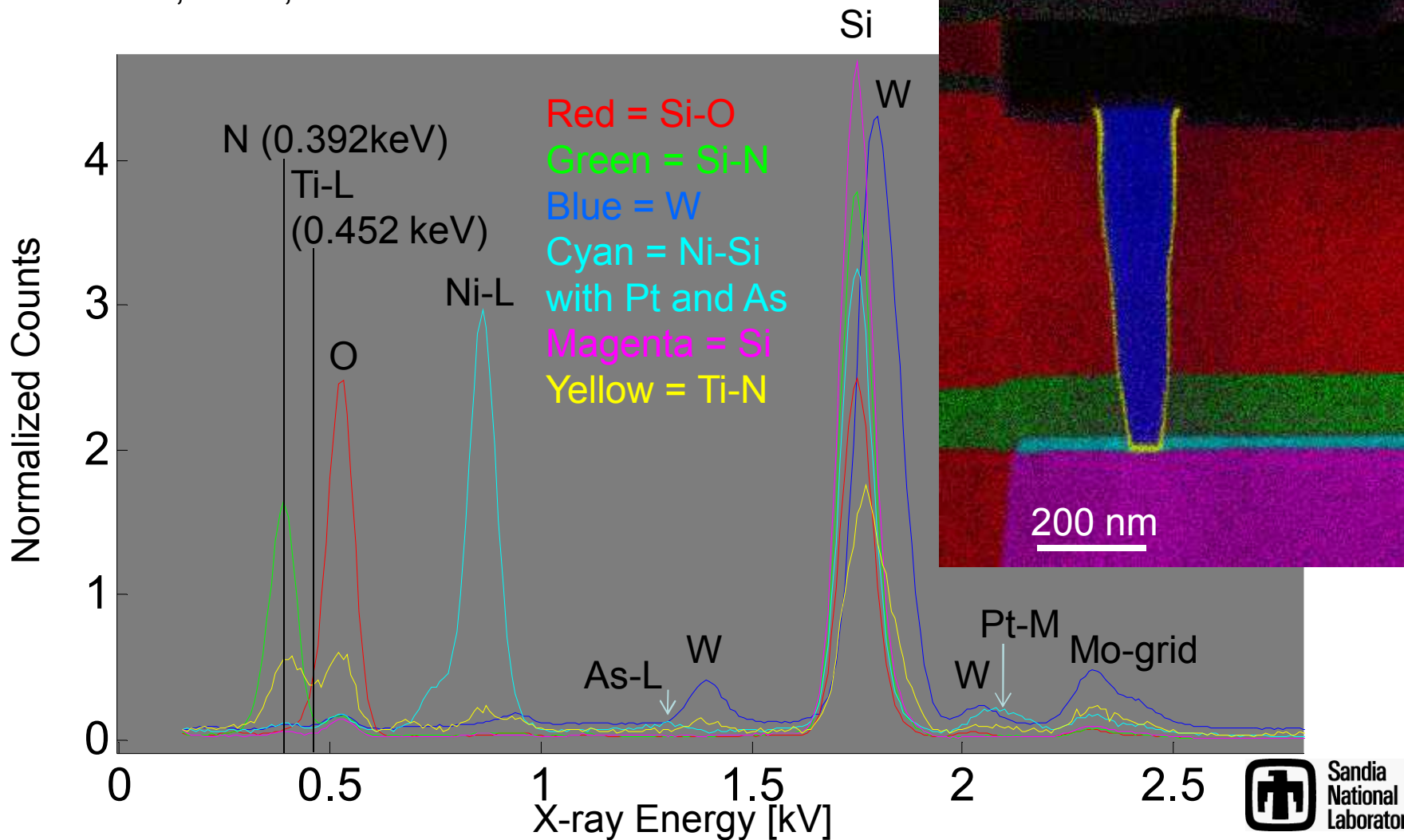
M.R. Keenan and P.G. Kotula, *Surf. Int. Anal.* **36 (2004) 203-212.

***P.G. Kotula et al. *Microsc. Microanal.* **9** (2003) 1-17.

Spatial-Domain Simplicity

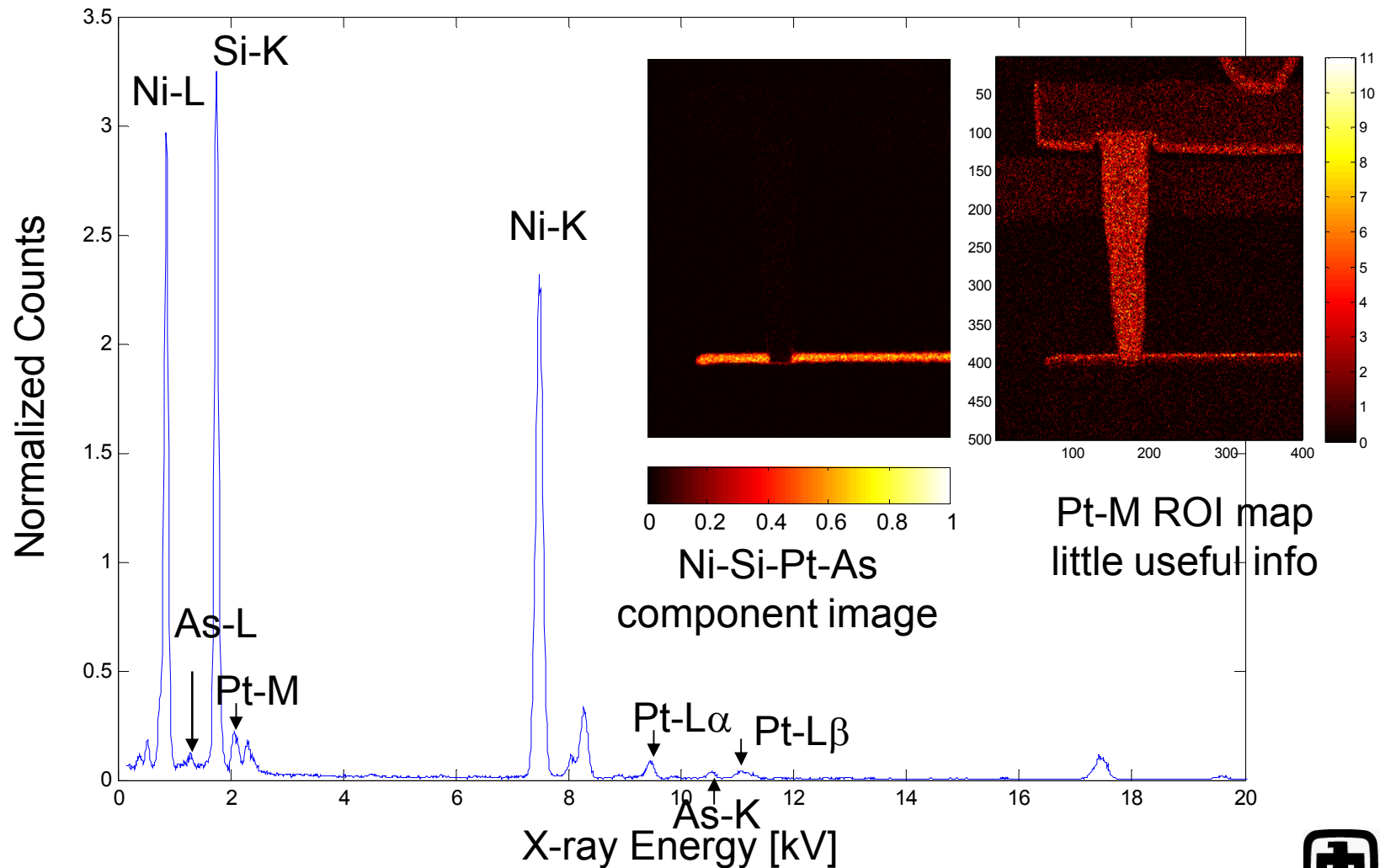
Best Spatial 'Contrast' (Phases)

Note Cu, Ta-Si, and low-k dielectric not shown



Spatial-Domain Simplicity

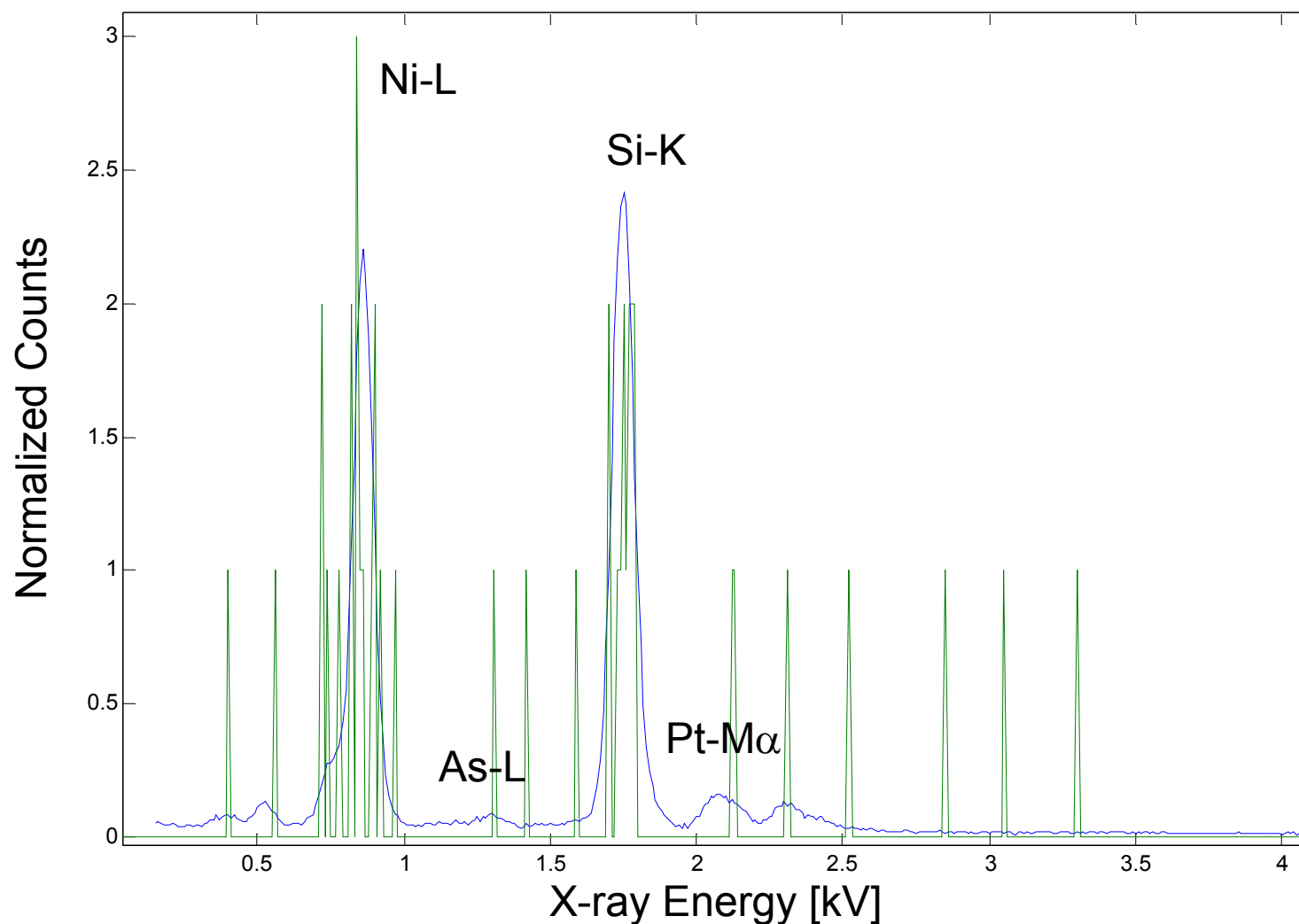
Ni-silicide contact, MSA shows minor elements



Spatial-Domain Simplicity

Ni-silicide contact, MSA shows minor elements

Raw versus MSA-processed





Spectral Domain Simplicity*

Often the elemental/correlated elemental viewpoint

- **$D = CS^T$ (Goal: Factor raw data into C and S...linear model)**

D is an m -pixel \times n -channel raw spectral-data matrix

S is an $n \times p$ matrix containing the p pure-component spectra shapes

C is an $m \times p$ matrix containing their spatial distributions/abundances

- Data is scaled to account for non-uniform (Poisson) noise**
- Number of factors to retain is chosen (Eigenanalysis)
- PCA is performed on the scaled data such the **spatial** components are orthogonal and the **spectral** components are orthonormal
- Rotate the orthonormal **spectral** components to maximize their mutual simplicity with the VARIMAX procedure
- Apply the inverse rotation to the **spatial** components which relaxes orthogonally in this domain
- Optionally: Impose non-negativity (e.g. via MCR-ALS)***
- Inversely scale the components for Poisson noise

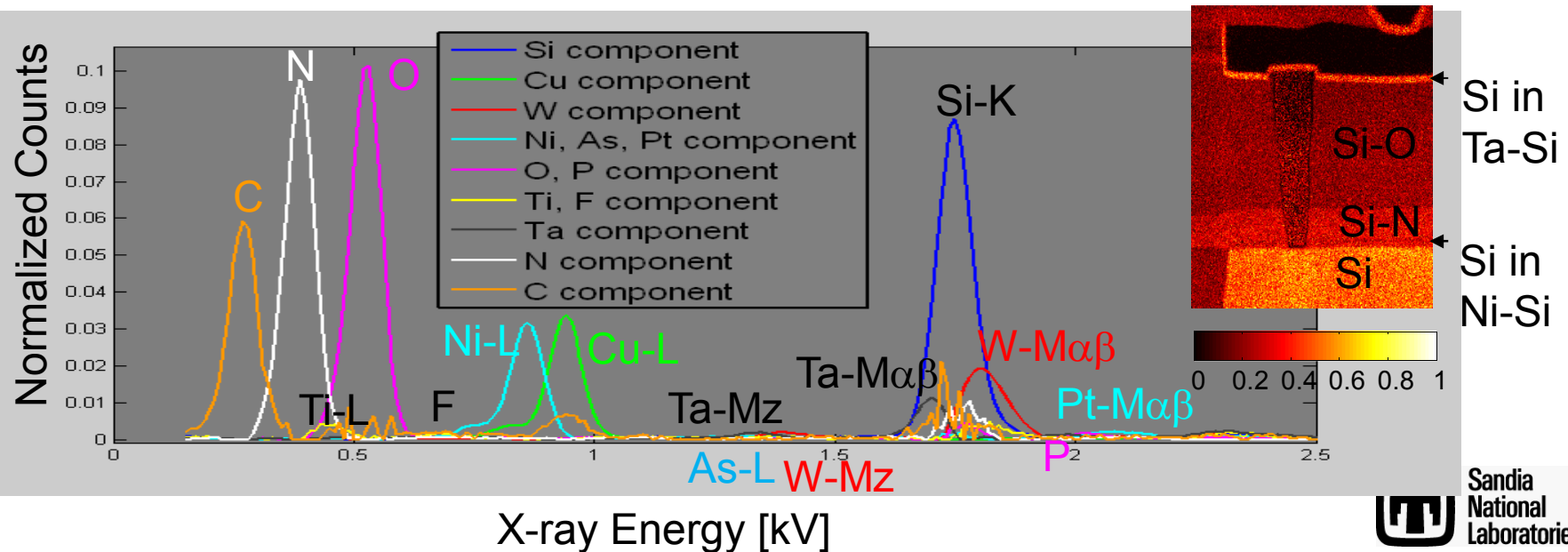
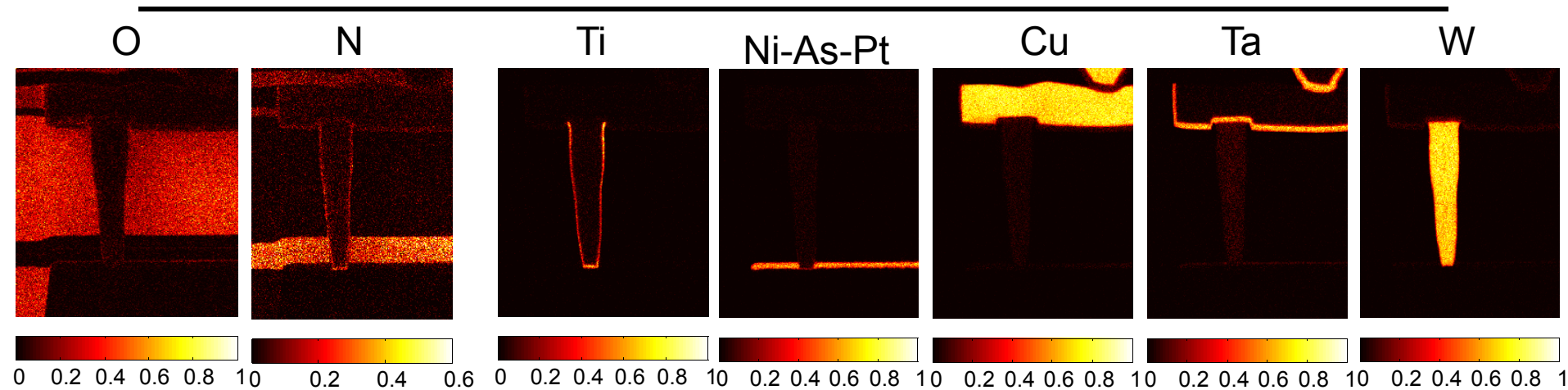
*M.R. Keenan, *Surf. Int. Anal.* **41** (2009) 79-87.

M.R. Keenan and P.G. Kotula, *Surf. Int. Anal.* **36 (2004) 203-212.

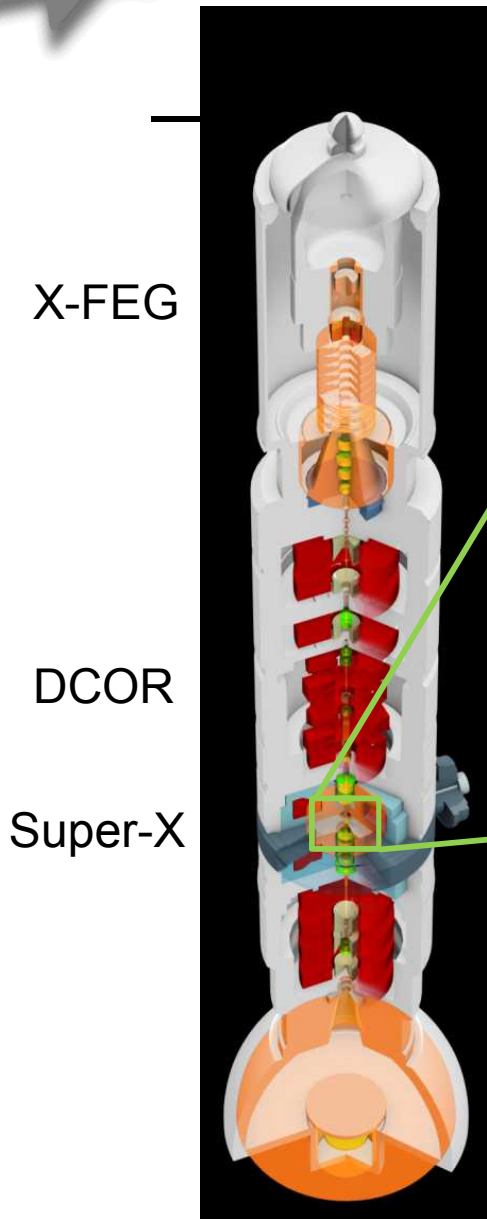
***P.G. Kotula et al. *Microsc. Microanal.* **9** (2003) 1-17.

Spectral-Domain Simplicity

Best Spectral or Elemental 'Contrast'



Atomic resolution x-ray microanalysis

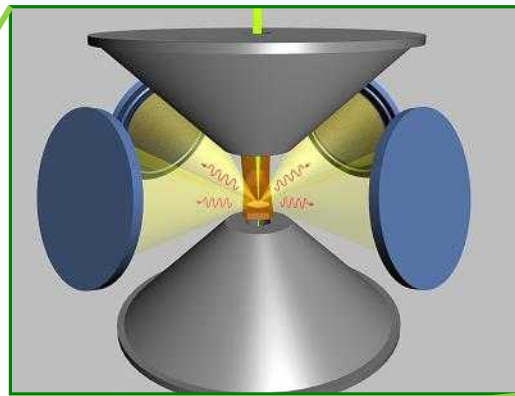


X-FEG

DCOR

Super-X

Critical elements for atomic resolution x-ray microanalysis

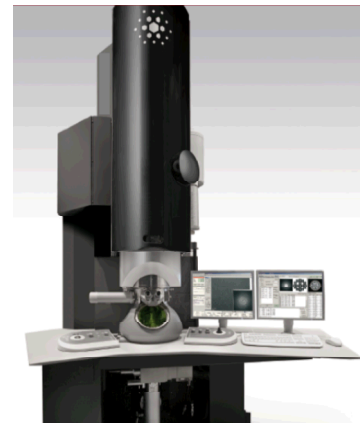


High brightness gun

Probe corrector

Efficient x-ray detector(s)

All of these elements have been integrated on the FEI Titan ChemiSTEM-P (200kV)





New Schottky emitter technology

- New Schottky emitter with the brightness of a cold FEG
- FEI X-FEG brightness increased to $\sim 10^8$ A/sr/m²/ V
 - $\sim 2 \times 10^9$ A/cm²/sr @ 200 kV
- Probe current (w/o corrector)
 - 0.5 nA in 0.3 nm diameter
 - **Increased by 5x** relative to regular Schottky FEG
- Probe current (with DCOR probe corrector)
 - 200 kV, 1.3 nA in 0.2 nm diameter probe
 - 80 kV, 0.5 nA in 0.2 nm diameter probe
- Energy-spread = 0.9 eV

Detector Efficiency: Arrays

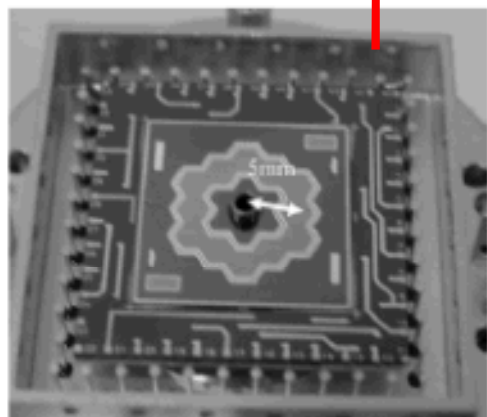
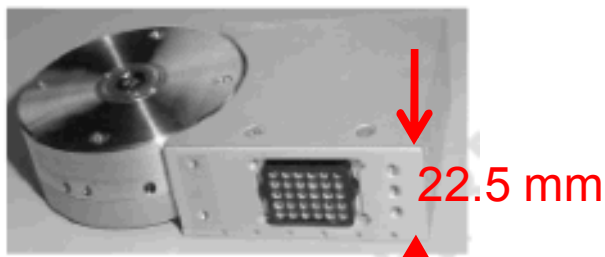
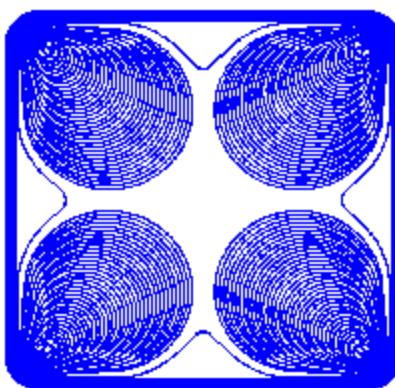
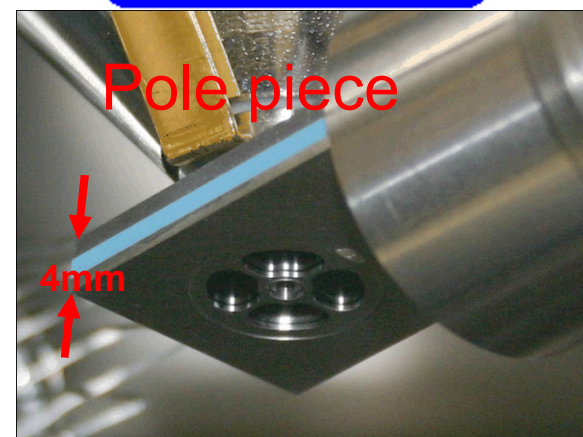
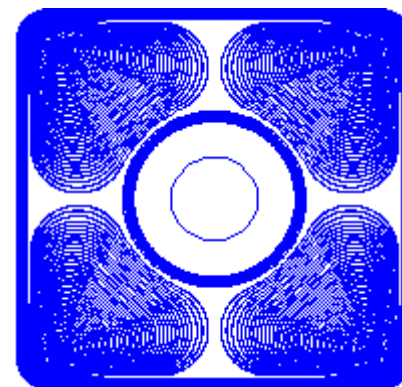


Figure 2. The Ketek 12-element annular SDD chip mounted in its package. The tantalum ion collimator that protects the SDD from scattered protons can be seen protruding through a hole in the center of the chip.

2005 Ketek/Custom imp.
2nd-3rd generation annular
(1.1 sr)



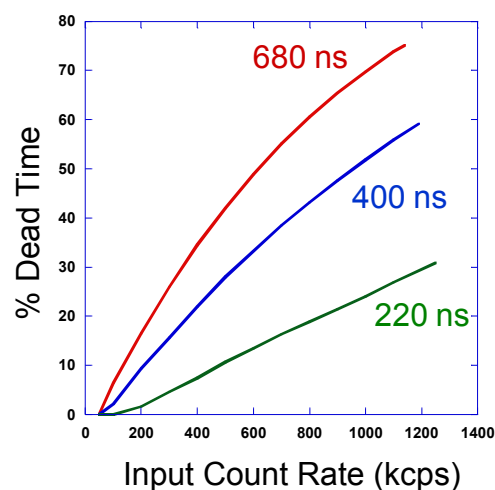
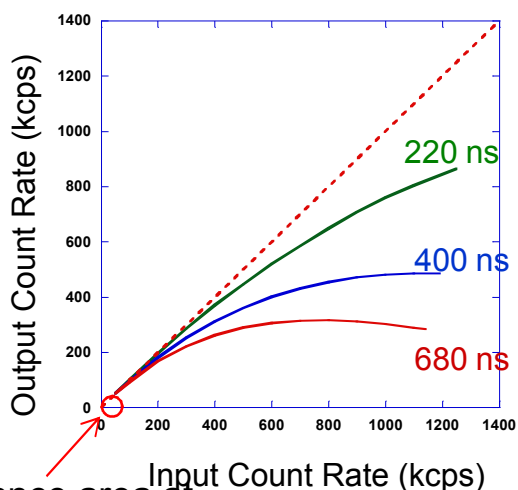
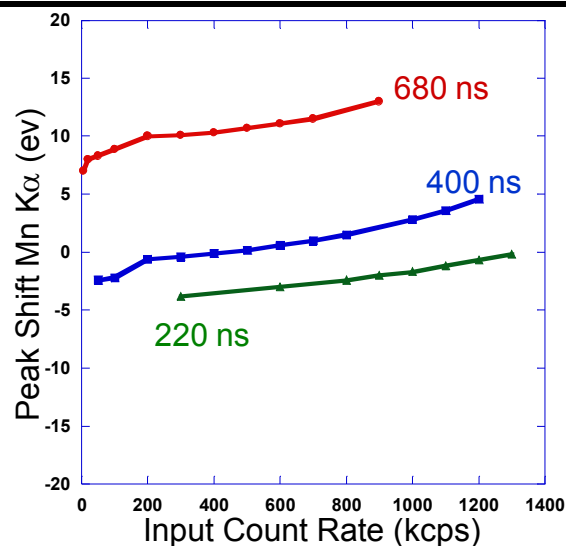
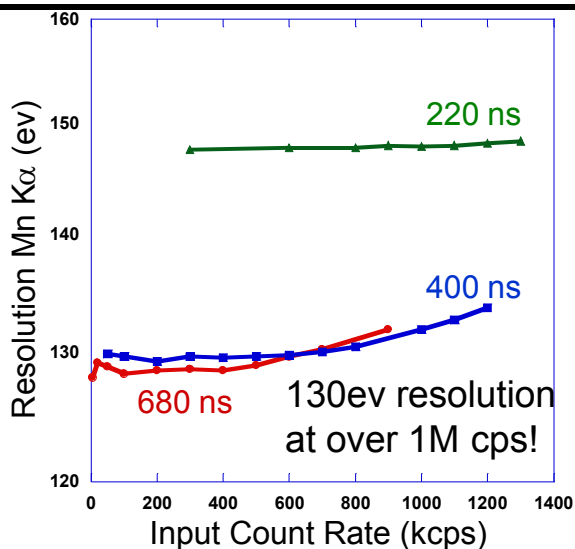
2005 pnSensor/Roentec
4-5th generation
conventional
(40 mm², 0.06 sr)



2007 pnSensor/Bruker
5th generation annular at
SNL(60 mm², 1.1 sr)

5th generation SDD performance

SEM data from 4-detectors summed

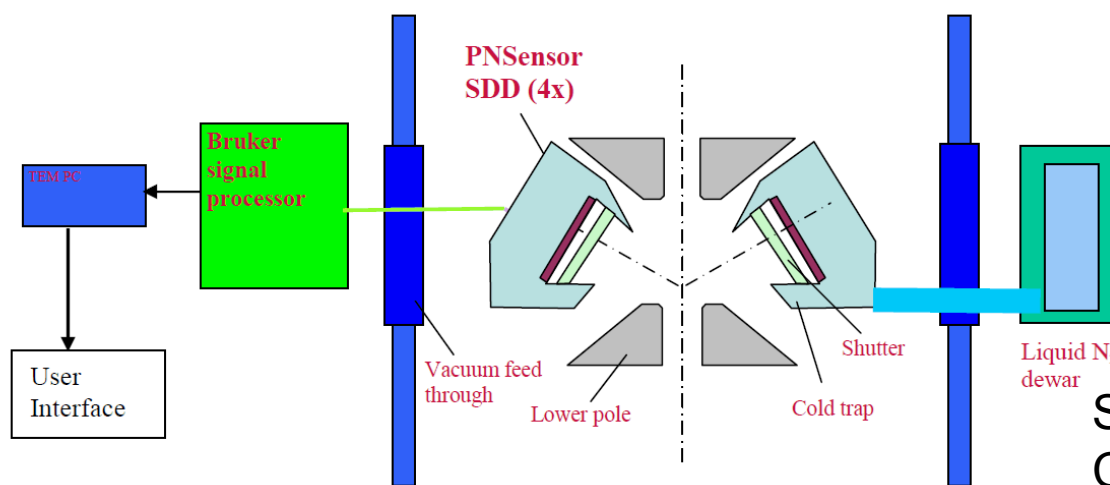


Si(Li) performance area at
180eV FWHM Mn-K α

Performance superior in every way to Si(Li)

Silicon drift detector in AEM provides more flexible integration

FEI/Bruker/pnSensor...SuperX™



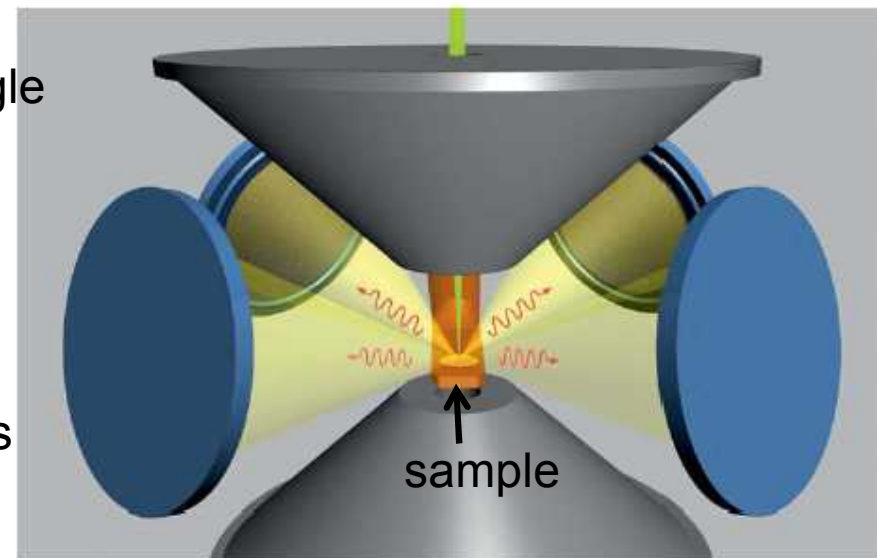
Field of the objective lens keeps electrons from hitting sensors

**Revolutionary
changes in AEM-EDS**

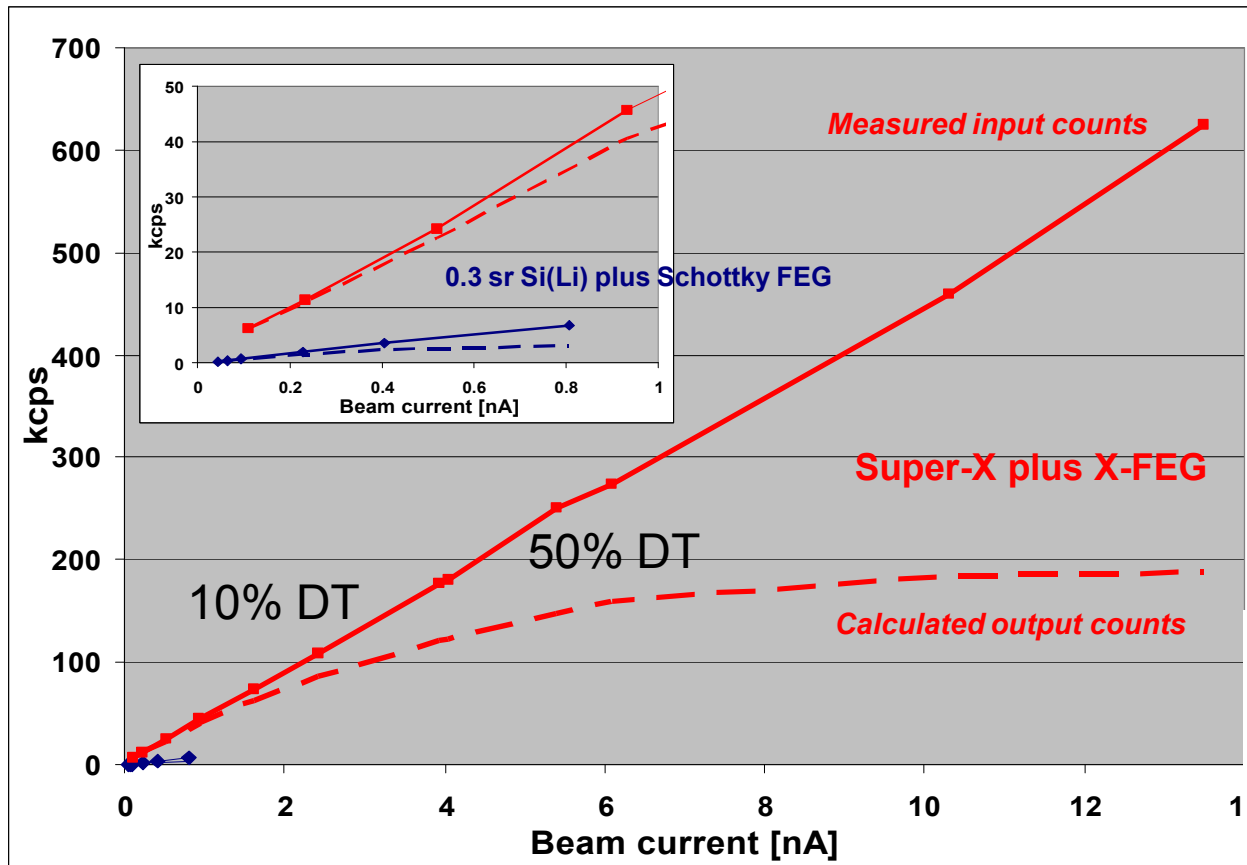
SDDs cooled by the cold finger.
Cooler than needed but no Peltier.

Figure 1. Schematic of Super-X detector

- 4-30mm² (120mm²) SDDs with large solid angle
 - 0.9 sr (Osiris-uncorrected)
 - 0.7 sr (Titan-probe corrected)
 - State-of-the-art SDDs
 - Windowless & pnWindow...good light-element performance (C, N, O previously)
 - High-throughput...10 μsec instantaneous dwell times, multiple pass, drift correction

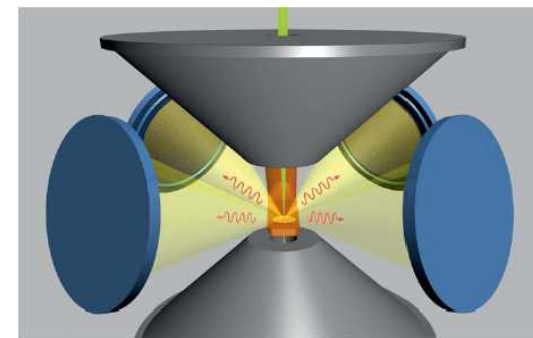


FEI/Bruker/pnSensor...SuperX™ Detector Performance



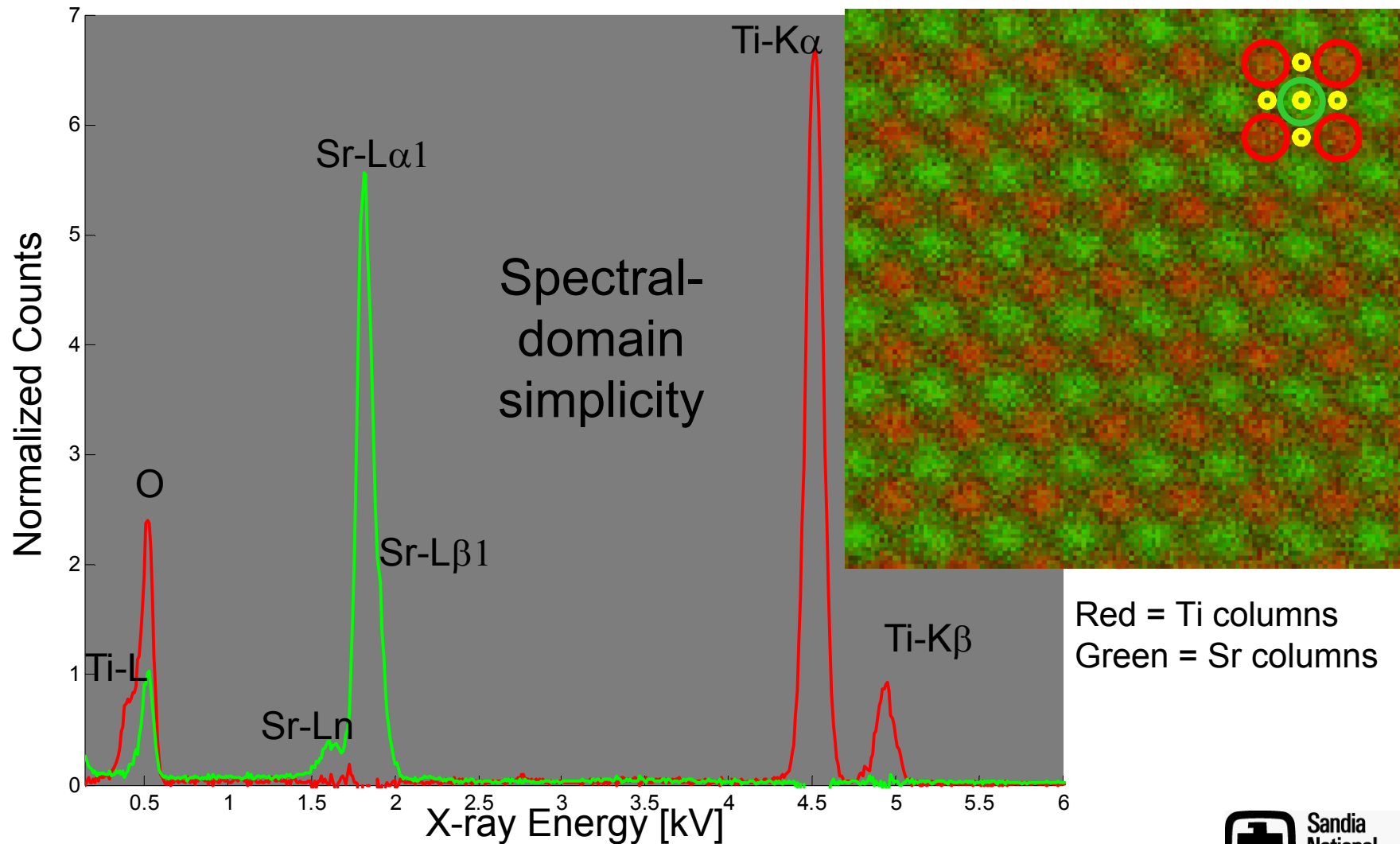
In both experiments the same FIB-cut InP sample was used with a thickness of about 200 nm.

Note: 1000 nsec
shaping time
136 eV FWHM Mn-K α



Example: SrTiO₃ [100]

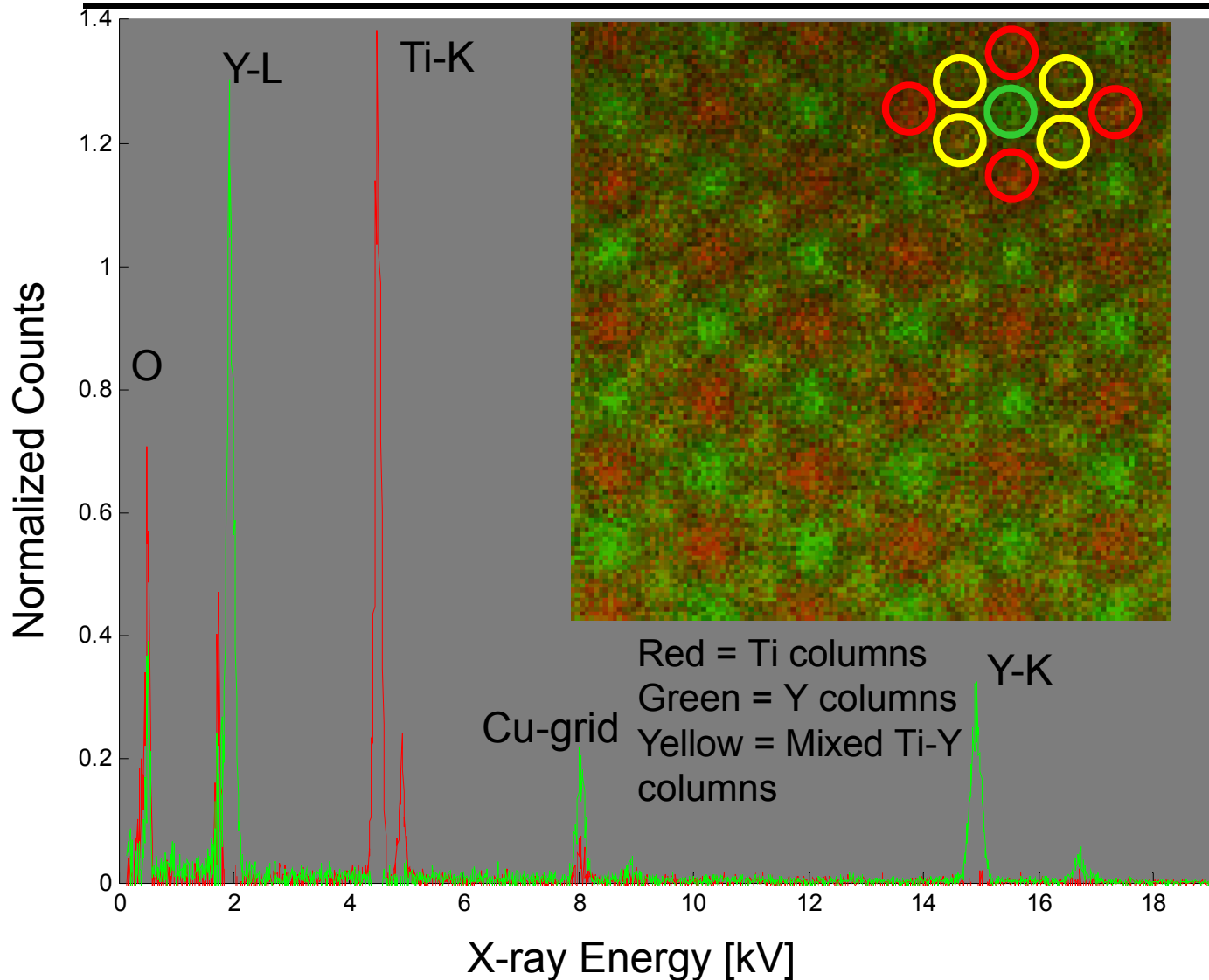
MSA-processed spectral image of SrTiO₃ with no *a priori* information



Sr-K lines not shown but correlate with Sr-L

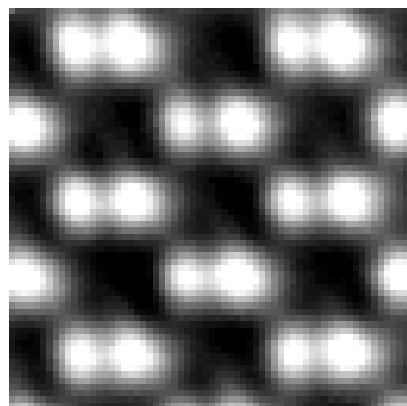
Example: $\text{Y}_2\text{Ti}_2\text{O}_7$ Pyrochlore [011]

128x128 Spectral image, 4x compression, Spectral domain simplicity

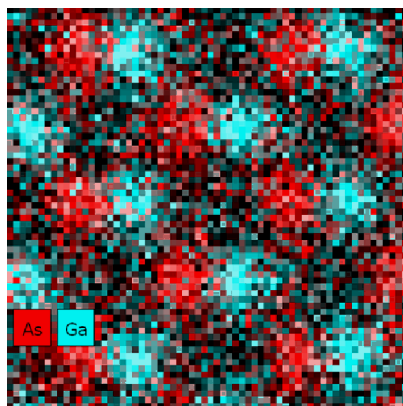


Example: GaAs [110]

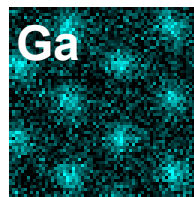
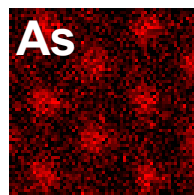
No MSA applied here



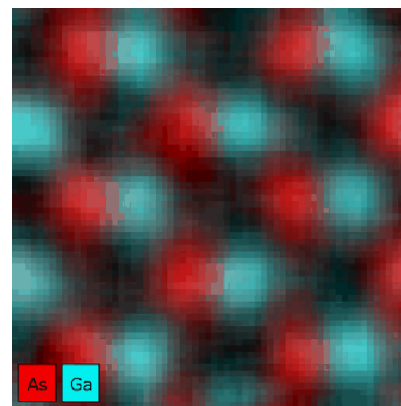
Raw images



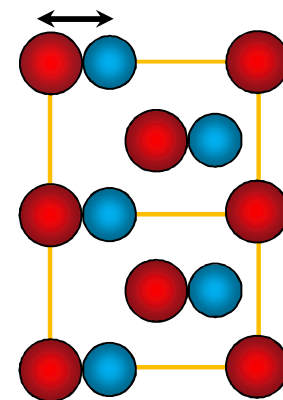
K-lines



filtered images



0.14 nm



● - As ● - Ga

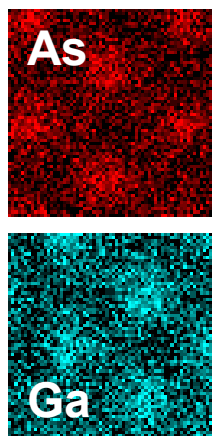
64 x 64 pixel
200 pA beam current
917 sec total time
220 msec/pixel

Titan G2 @200 kV
probe-corrected (DCOR)
X-FEG, SuperX

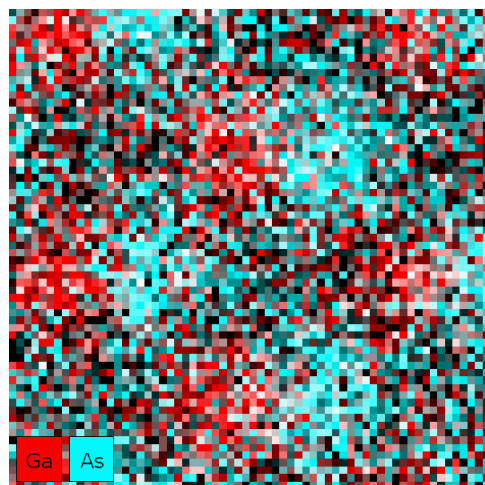
Example: GaAs [110]

MSA applied here with no *a priori* information

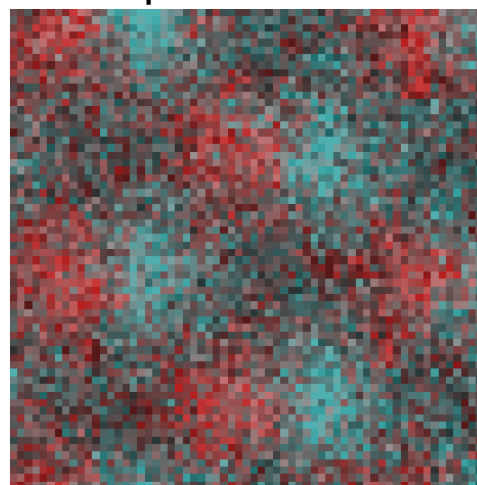
Raw maps



Raw K-lines ROI overlay



MSA results, K and L line overlaps ~deconvoluted



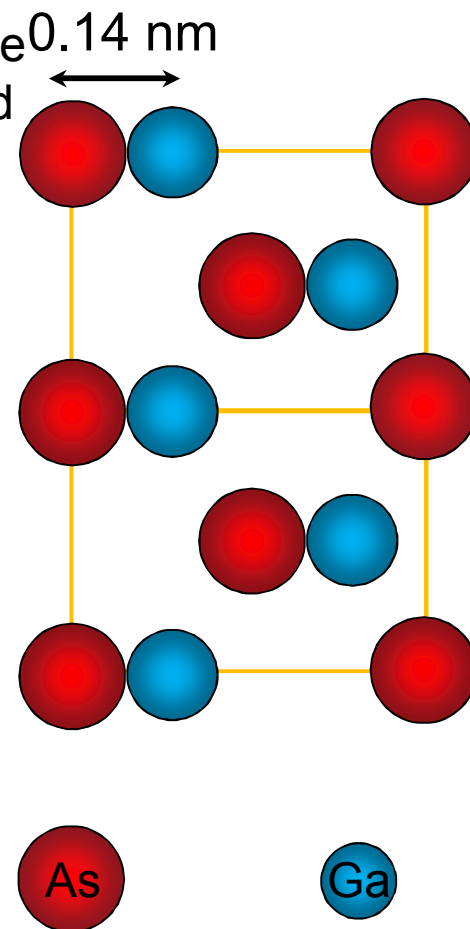
64 x 64 pixel

247 pA beam current

68 sec total time

17 msec/ pixel

Titan G2 @200 kV
probe-corrected (DCOR)
X-FEG, SuperX



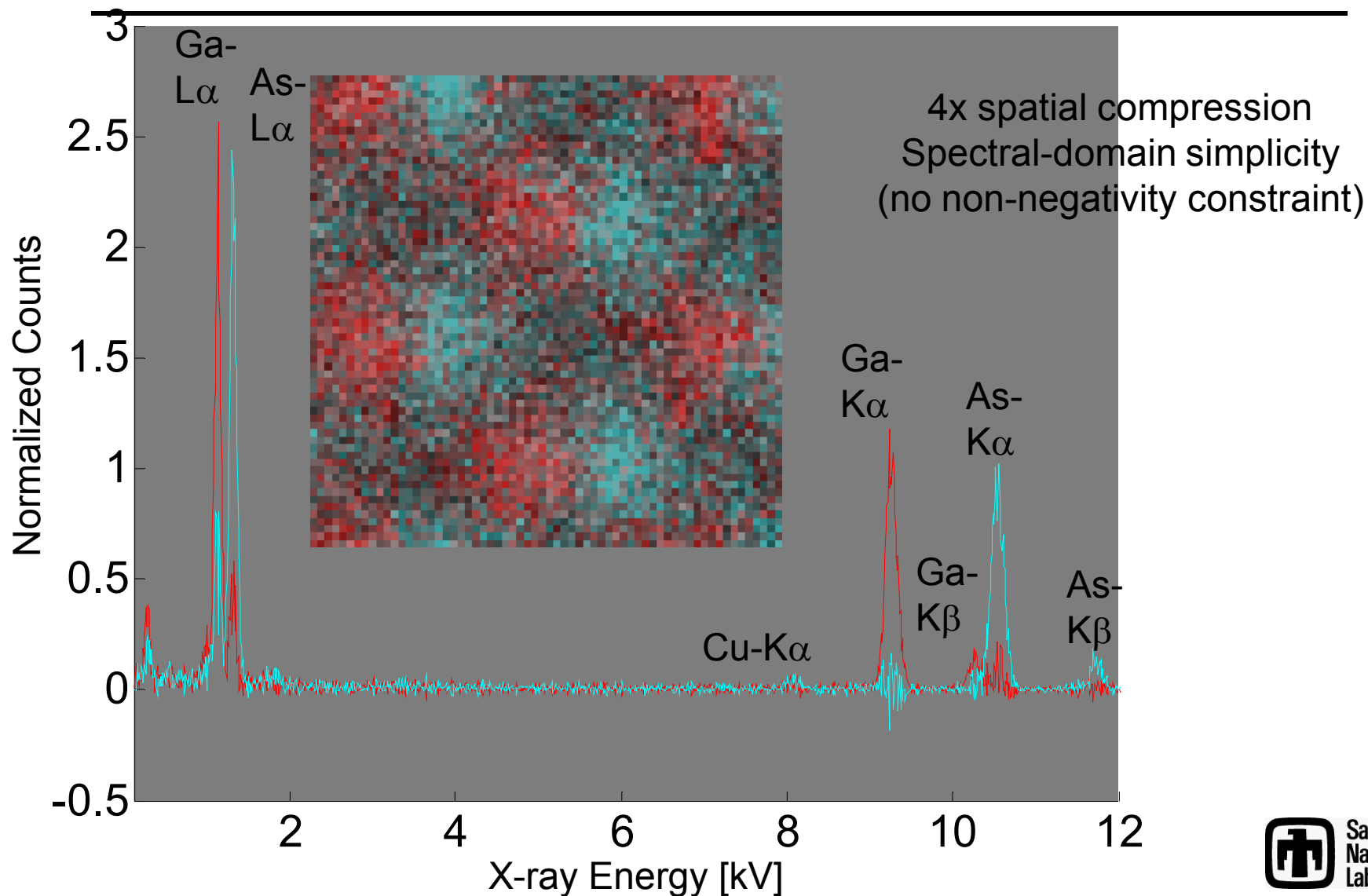
~413k counts in the spectral image

Max counts in any channel is 10

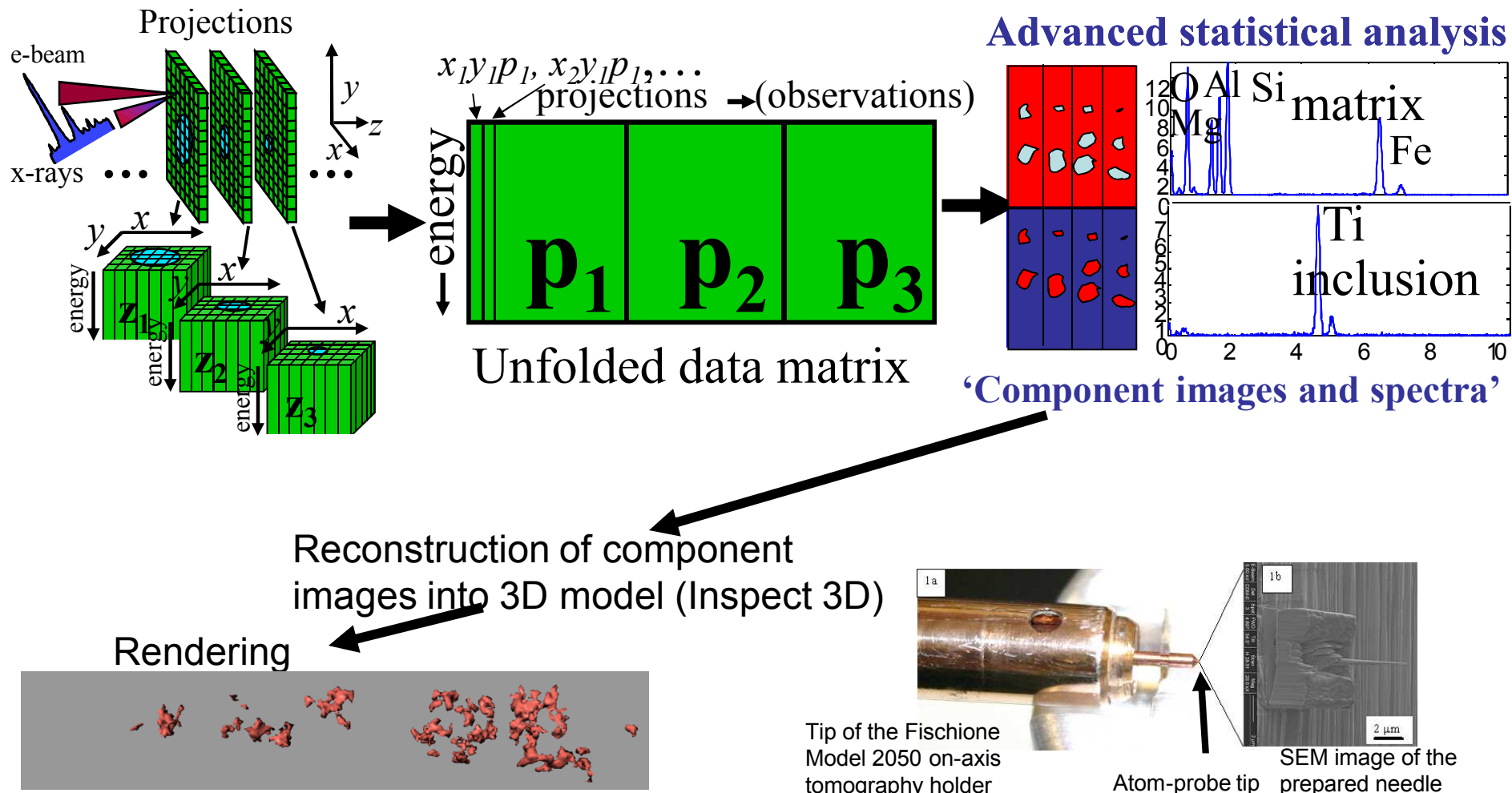
Average of 100 counts per spectrum

**MSA analysis took 300 msec with
AXSIA**

GaAs [110]: MSA component overlay



Tomographic Spectral Imaging and Multivariate Statistical Analysis

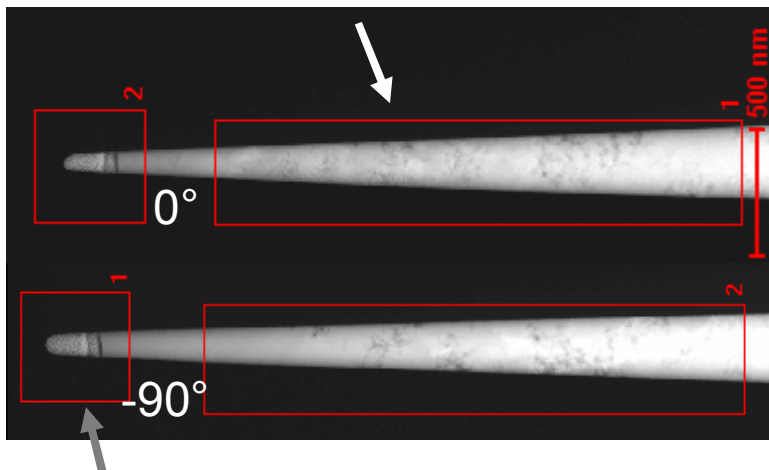


MSA of the entire projection series

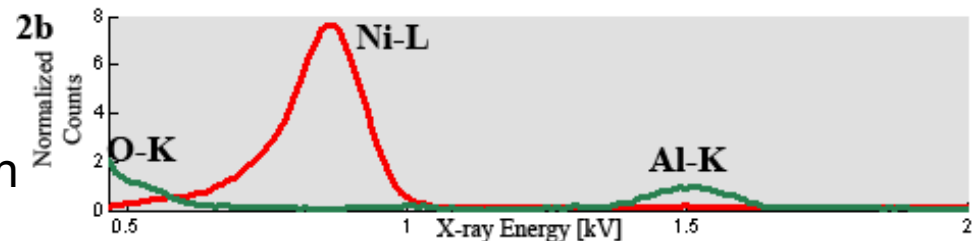
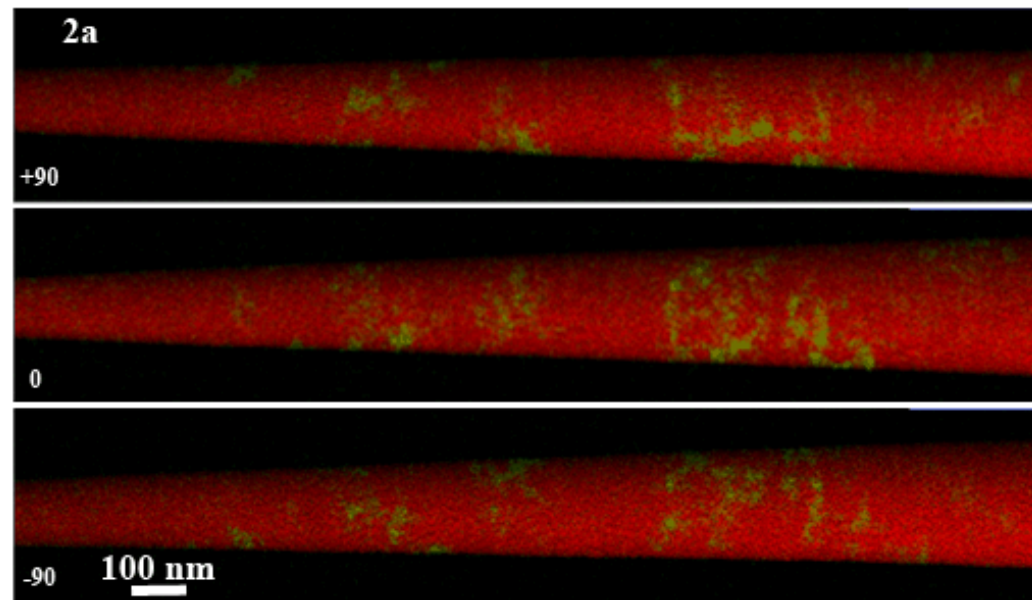
FEI Tecnai F30-ST, 0.1sr

Color overlays of component images

Region of spectral
images 2000nm x 400nm



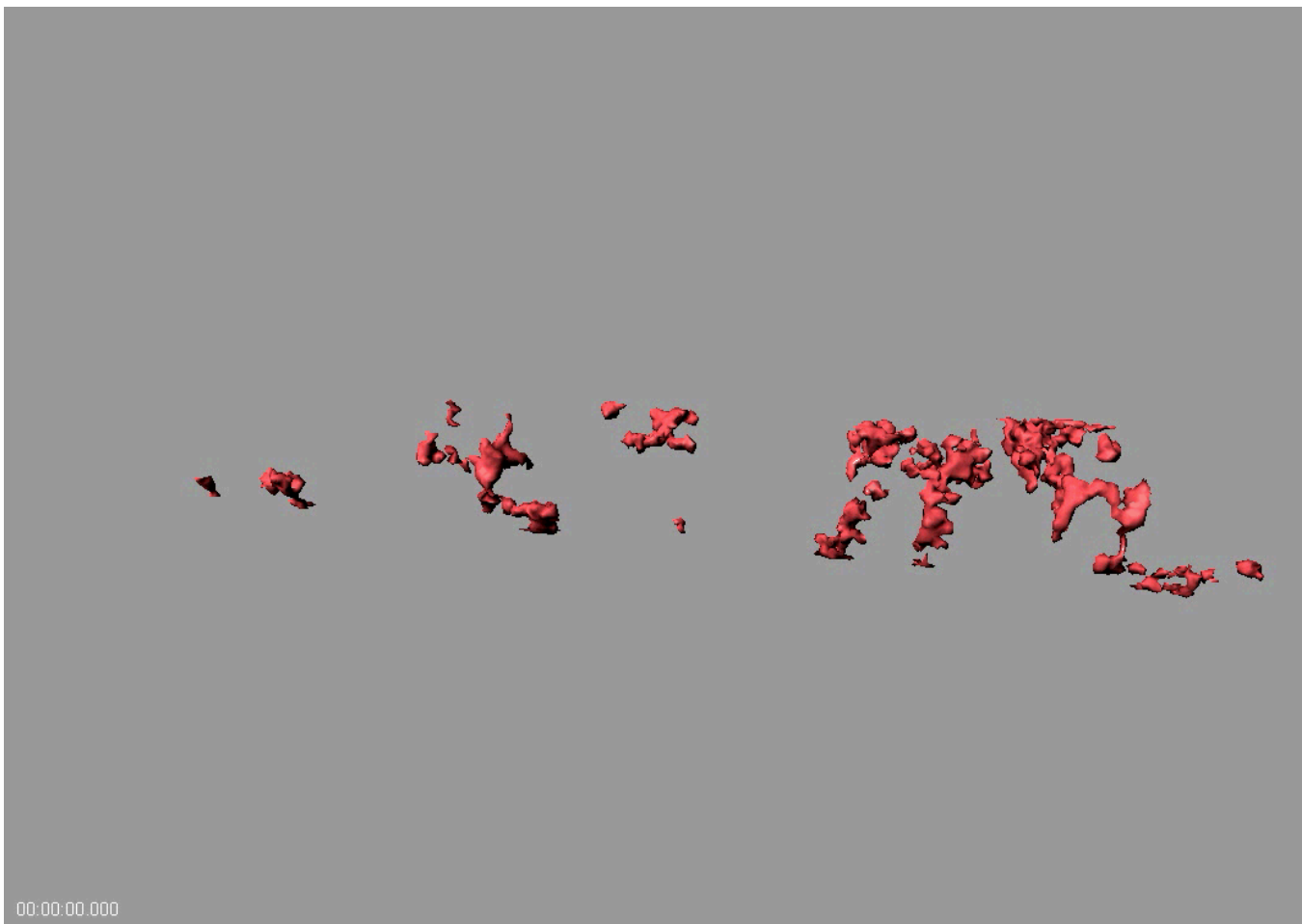
Drift-correction region



19 hours (over 3 days) of data acquisition

P.G. Kotula, et al. Microsc. Microanal. 13 (Suppl2), 2007 1324CD-1325CD

Reconstructed isosurface of the alumina particles





Conclusions

- AEM is undergoing a renaissance with correctors, SDDs, novel diffraction techniques, and better sources.
- Atomic resolution EDS will become more common than EELS. More elements accessible, esp. heavy ones.
- Novel detector geometries for AEM improve sensitivity and throughput.
- MSA methods are very useful for simplifying the analysis of large, complex data sets
 - Importance of Poisson normalization
 - Factor rotation, spatially or spectrally simple viewpoints
 - Unbiased analysis powerful for materials science, etc. Needle in the haystack....single atoms....
- Quantitative analysis pushed to smaller volumes
 - Understanding the spectrum is critical...every bump matters!
 - Potential for 1000 ppm sensitivity at 0.2 nm?
 - 100 ppm sensitivity at 1 nm?
- Practical computed tomographic spectral imaging

Joe Michael's 0.1 wt.% Mn-Cu

